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# Synergistic Cu nanoparticles and Cu single atoms leveraging hydrogen spillover for selective CO electroreduction to acetate

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The electrochemical reduction of CO to acetate on Cu-based catalysts is constrained by a kinetic trade-off between CO activation and the availability of active hydrogen (\*H) species. Herein, we overcome this limitation by constructing a synergistic catalyst comprising Cu nanoparticles and Cu single atoms (Cu<sub>NP</sub>-Cu<sub>1</sub>), which leverages a hydrogen spillover mechanism. The Cu<sub>1</sub> sites facilitate water dissociation to generate \*H, which subsequently spills over to adjacent Cu NPs, enabling efficient hydrogenation of the \*OCCO intermediate, with subsequent formation of \*CCO selectively. This synergy delivers an acetate faradaic efficiency of 60.6% with an acetate partial current density of 111.1 mA cm<sup>-2</sup> and stable operation for 132 h. *Operando* spectroscopy measurements and theoretical calculations collectively reveal that the Cu<sub>1</sub>-mediated hydrogen spillover shifts the reaction pathway toward acetate formation. This work establishes hydrogen spillover as a design principle for coordinating multistep reactions in CO electroreduction.

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## Introduction

The electrochemical reduction of CO to multicarbon (C<sub>2+</sub>) products represents a promising strategy for the sustainable production of high-value chemicals. Acetate, a key intermediate, finds extensive applications in fine chemicals, pesticides, fuels, and pharmaceuticals.<sup>1,2</sup> Although the formation of acetate is thermodynamically favorable, with a theoretical CO/acetate redox potential of 0.09 V *versus* the reversible hydrogen electrode (*vs.* RHE),<sup>3</sup> the catalytic process remains kinetically sluggish. The multi-proton-electron coupled transfer reaction poses a significant kinetic barrier, limiting the efficient conversion of CO to acetate.<sup>4</sup> To improve acetate selectivity, significant efforts have been focused on enhancing C-C coupling and increasing current density.<sup>5-7</sup> Strategies including optimizing crystal facets,<sup>8,9</sup> morphology,<sup>10</sup> interfaces,<sup>11</sup> and alloying<sup>12-14</sup> have been reported in recent years.

Cu stands out among metal catalysts owing to its unique ability to facilitate C-C coupling during CO electrochemical

reduction, enabling the synthesis of valuable C<sub>2+</sub> compounds.<sup>15-17</sup> Cu nanoparticles (NPs) exhibit favorable \*CO adsorption thermodynamics and low C-C coupling barriers, making them efficient for generating C<sub>2+</sub> products *via* \*CO electroreduction.<sup>18,19</sup> As a result, Cu NPs typically enable appreciable formation of ethylene and ethanol.<sup>20,21</sup> However, the formation of the \*OCCOH intermediate is widely recognized as a pivotal step in C<sub>2+</sub> product generation, with its subsequent hydrogenation and dehydration *via* the ketene intermediate (\*C=C=O) selectively driving the reaction pathway toward acetate formation, which is kinetically constrained by the limited availability of active hydrogen (\*H) species on Cu surfaces.<sup>22-25</sup>

Hydrogen spillover has emerged as a key mechanism to regulate interfacial \*H abundance, lowering the energy barrier for C-C coupling.<sup>26,27</sup> Recently, single-atom Cu catalysts (Cu<sub>1</sub>) have been shown to facilitate water dissociation for efficient \*H generation, promoting the conversion of \*CO to \*CHO.<sup>28</sup> It is widely reported that the synergistic increase in the \*H and \*CO surface coverage kinetically steers the reaction pathway toward asymmetric C-C coupling *via* preferential \*CO hydrogenation.<sup>29-31</sup> In such a scenario, synergistic catalysis is expected to be a feasible strategy to balance the \*CO adsorption and the hydrogenation kinetics of carbon intermediates.

Herein, we construct a synergistic catalyst by introducing Cu single atoms onto Cu NPs (Cu<sub>NP</sub>-Cu<sub>1</sub>) for electrochemical CO reduction to acetate, with a faradaic efficiency of 60.6%, a partial current density of 111.1 mA cm<sup>-2</sup> and durability for 132 hours. Electrochemical CO stripping experiments, *operando*

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Raman spectroscopy and H/D kinetic isotope effect (KIE) studies reveal that Cu NPs facilitate C–C coupling by effectively adsorbing CO molecules and Cu single atoms enhance the dissociation of H<sub>2</sub>O to generate active \*H species, promoting hydrogen spillover from Cu<sub>1</sub> sites to Cu<sub>NP</sub>. Density functional theory (DFT) calculations incorporating *ab initio* molecular dynamics (AIMD) simulations indicate that the modulated \*H coverage thermodynamically drives the formation of key intermediates, ultimately enhancing acetate production. This work establishes hydrogen spillover engineering as a general strategy to coordinate multistep reactions in CO electroreduction systems.

## Results and discussion

### Structural and morphological characterization

The Cu<sub>NP</sub>–Cu<sub>1</sub> catalyst was synthesized *via* the pyrolysis of a Cu coordination polymer under Ar flow (Fig. S1). The scanning electron microscopy (SEM) image, as illustrated in Fig. 1a, reveals a smooth and granular texture. The transmission electron microscopy (TEM) image of Cu<sub>NP</sub>–Cu<sub>1</sub> (Fig. 1b) reveals the presence of Cu NPs (Cu<sub>NP</sub>) with an average size of 3.1 nm within the Cu<sub>NP</sub>–Cu<sub>1</sub> catalyst (see SEM and TEM images in Fig. S2). Aberration-corrected high-angle annular dark-field scanning transmission electron microscopy (HAADF-STEM) images (Fig. 1c) reveal that Cu single atoms (highlighted by red circles) are densely dispersed around Cu nanoparticles with an average

inter-site distance of approximately 0.22 nm (Fig. S3). Such atomic-level spatial proximity is essential for efficient hydrogen spillover, as it minimizes the migration distance of \*H species between Cu<sub>1</sub> and Cu<sub>NP</sub> surfaces.<sup>32</sup> A lattice spacing of 0.20 nm for the Cu<sub>NP</sub> is consistent with the (111) crystal plane of metallic Cu, confirmed by the intensity profile derived from the STEM image (Fig. 1d). For comparison purposes, we prepared 2Cu<sub>NP</sub>–Cu<sub>1</sub> (doubled copper salt, Fig. S4), Cu NPs (Cu nanoparticles loaded on XC72R, Fig. S5a) and CuSA (Cu single atom, Cu<sub>NP</sub>–Cu<sub>1</sub> etched with H<sub>2</sub>SO<sub>4</sub> to remove Cu<sub>NP</sub>, Fig. S5b and c). X-ray diffraction (XRD) patterns of Cu<sub>NP</sub>–Cu<sub>1</sub>, and Cu NPs (Fig. 1e) show characteristic peaks attributed to metallic copper and carbon, with a prominent peak at 43.2° corresponding to the Cu (111) plane. In contrast, the XRD pattern of CuSA exhibited typical diffraction patterns of amorphous carbon, with no discernible peaks attributable to copper. Energy-dispersive X-ray spectroscopy (EDS) elemental mapping (Fig. 1f) indicates a uniform distribution of C, N, and Cu on the carbon matrix, suggesting that these elements are evenly dispersed.

To further elucidate the precise coordination structure and chemical state of Cu within the catalyst, X-ray absorption near-edge structure (XANES) and extended X-ray absorption fine structure (EXAFS) characterization studies were employed. Fig. 2a shows the Cu K-edge XANES spectra of Cu<sub>NP</sub>–Cu<sub>1</sub>, 2Cu<sub>NP</sub>–Cu<sub>1</sub>, Cu foil, and CuPc. The absorption edge position for Cu<sub>NP</sub>–Cu<sub>1</sub> lies between those of Cu foil and CuPc, indicating that the average oxidation state of Cu in the catalyst is between



**Fig. 1** (a) SEM and (b) TEM images of the Cu<sub>NP</sub>–Cu<sub>1</sub> catalyst. (c) Aberration-corrected HAADF-STEM image of the Cu<sub>NP</sub>–Cu<sub>1</sub> catalyst (the blue lattices represent the crystal model formed by expanding the unit cell of FCC copper into a 3 × 3 × 3 supercell). (d) Intensity profiles measured from HAADF-STEM images of the Cu<sub>NP</sub>–Cu<sub>1</sub> catalyst. (e) XRD patterns of Cu NPs, Cu<sub>NP</sub>–Cu<sub>1</sub> and CuSA. (f) EDS elemental maps of the Cu<sub>NP</sub>–Cu<sub>1</sub> catalyst.





**Fig. 2** (a) Cu K-edge XANES spectra of  $\text{Cu}_{\text{NP}}\text{-Cu}_1$  and  $2\text{Cu}_{\text{NP}}\text{-Cu}_1$ , in comparison to Cu foil and CuPc. (b) Fourier-transform (FT)-EXAFS spectra of  $\text{Cu}_{\text{NP}}\text{-Cu}_1$ ,  $2\text{Cu}_{\text{NP}}\text{-Cu}_1$ , Cu foil and CuPc. FT-EXAFS spectral fittings for (c) Cu foil and (d) the  $\text{Cu}_{\text{NP}}\text{-Cu}_1$  catalyst. (e) Wavelet-transform (WT)-EXAFS of  $\text{Cu}_{\text{NP}}\text{-Cu}_1$ , CuPc and Cu foil at the Cu K-edge.

0 and +2. This suggests the coexistence of  $\text{Cu}^0$  and  $\text{Cu}^{2+}$  species within the  $\text{Cu}_{\text{NP}}\text{-Cu}_1$  catalyst. The Fourier transform (FT) EXAFS spectra in  $R$ -space, shown in Fig. 2b, reveal distinct features. Cu foil exhibits a characteristic first shell Cu–Cu bond at 2.2 Å, while CuPc shows a Cu–N bond at 1.5 Å. In contrast,  $\text{Cu}_{\text{NP}}\text{-Cu}_1$  and  $2\text{Cu}_{\text{NP}}\text{-Cu}_1$  display two bond lengths at 1.5 Å and 2.2 Å, corresponding to Cu–N and Cu–Cu bonds, respectively.<sup>33,34</sup> The Fourier-transformed EXAFS fitting plots and  $k^3$ -weighted Cu K-edge EXAFS spectra of Cu foil and  $\text{Cu}_{\text{NP}}\text{-Cu}_1$  catalysts demonstrate a good fitting quality of the EXAFS data (Fig. 2c, d and S6). Additionally, wavelet transform (WT)-EXAFS analysis was conducted on the Cu K-edge of  $\text{Cu}_{\text{NP}}\text{-Cu}_1$ , Cu foil, and CuPc (Fig. 2e). Cu foil exhibits a maximum WT intensity at  $k = 7.0 \text{ \AA}^{-1}$ , indicative of Cu–Cu coordination, whereas CuPc shows a maximum WT intensity at  $k = 6.0 \text{ \AA}^{-1}$ , corresponding to Cu–N coordination. Notably,  $\text{Cu}_{\text{NP}}\text{-Cu}_1$  presents maxima at both  $k = 6.0 \text{ \AA}^{-1}$  and  $k = 7.0 \text{ \AA}^{-1}$ , confirming the presence of both Cu–Cu and Cu–N bonds. The EXAFS fitting yields an average Cu–N coordination number of 2.7, consistent with a distribution of coordination environments where  $\text{Cu-N}_3$  is the dominant motif (Table S1). DFT calculations based on a representative  $\text{Cu-N}_3$  model were employed to elucidate the mechanistic role of the Cu single-atom sites. This evidence further corroborates the coexistence of Cu single atoms and Cu NPs in  $\text{Cu}_{\text{NP}}\text{-Cu}_1$ , aligning with HAADF-STEM observations.

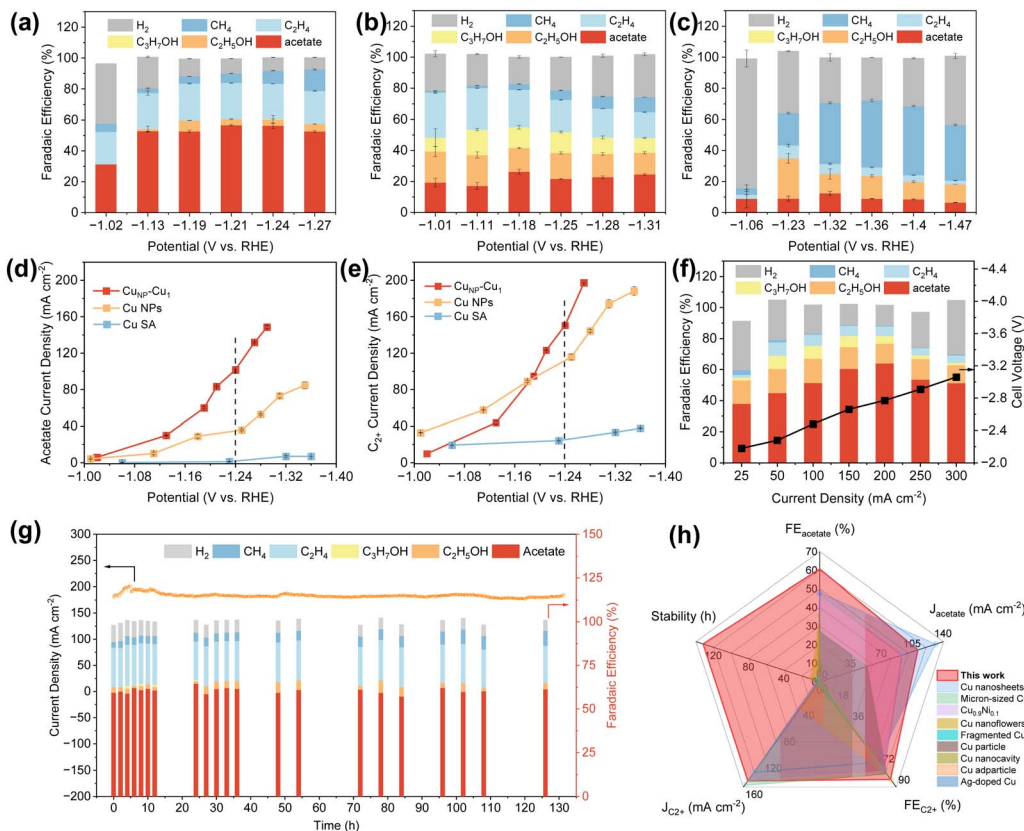
## Electrochemical CO reduction performance

The electrochemical performance of  $\text{Cu}_{\text{NP}}\text{-Cu}_1$  was evaluated in a flow cell (Fig. S7). Fig. S8 shows a notable increase in cathodic current density when the feed gas was switched from Ar to CO. The mass loading of the  $\text{Cu}_{\text{NP}}\text{-Cu}_1$  catalyst on carbon paper was optimized to assess CO reduction reaction (CORR) performance. As shown in Fig. 3a and S9, the catalyst with a mass loading of  $0.5 \text{ mg cm}^{-2}$  led to a prominent acetate partial current density. The catalytic performance of  $\text{Cu}_{\text{NP}}\text{-Cu}_1$  was benchmarked against Cu NPs and CuSA under identical conditions (Fig. 3a–e). Notably, the faradaic efficiency (FE) for acetate over the  $\text{Cu}_{\text{NP}}\text{-Cu}_1$  catalyst reaches 57.6% at  $-1.24 \text{ V vs. RHE}$  with a partial current density of  $103.9 \text{ mA cm}^{-2}$ . In contrast, the sum of acetate FE from Cu NPs (FE  $\sim 20\%$ ) and CuSA (FE  $\sim 10\%$ ) individually is substantially lower than that of  $\text{Cu}_{\text{NP}}\text{-Cu}_1$ , providing a clear indication of synergistic enhancement rather than simple additive effects (Fig. 3a–d). The partial current densities of acetate and  $\text{C}_{2+}$  products on  $\text{Cu}_{\text{NP}}\text{-Cu}_1$ , Cu NPs, and CuSA show a sustained increase as the applied potential shifts negatively (Fig. 3d and e). The faradaic efficiency for  $\text{C}_{2+}$  products on  $\text{Cu}_{\text{NP}}\text{-Cu}_1$  reaches 83.4% with a partial current density of  $150.5 \text{ mA cm}^{-2}$  (Fig. 3e and S10). The carbon selectivity distribution among CO electrolysis products exhibits pronounced disparities in carbonaceous product formation.  $\text{Cu}_{\text{NP}}\text{-Cu}_1$  demonstrates an exceptional acetate selectivity of approximately 80%, whereas Cu NPs and CuSA catalysts show substantial reductions in acetate production efficiency (Fig. S11). Moreover, commercial Cu NPs (25 nm) also exhibit a product distribution similar to Cu NPs (Fig. S12).

To further probe the origin of this synergy, we systematically varied the  $\text{Cu}_{\text{NP}}/\text{Cu}_1$  ratio by quantifying CuSA and Cu NPs in the  $2\text{CuSA}$ ,  $\text{CuSA}$ ,  $0.5\text{CuSA}$ ,  $\text{Cu}_{\text{NP}}\text{-Cu}_1$ ,  $2\text{Cu}_{\text{NP}}\text{-Cu}_1$  and  $0.5\text{Cu}_{\text{NP}}\text{-Cu}_1$  catalysts by inductively coupled plasma-optical emission spectrometry (ICP-OES) measurements (Table S2) and evaluated their CORR performance (Fig. S13). A volcano-shaped relationship emerges between the  $\text{Cu}_{\text{NP}}/\text{Cu}_1$  ratio and acetate FE, with the optimal performance centered at  $\text{Cu}_{\text{NP}}\text{-Cu}_1$ . Catalysts with insufficient  $\text{Cu}_1$  sites suffer from limited  $^*\text{H}$  supply, while those with excessive  $\text{Cu}_1$  sites exhibit diminished C–C coupling due to insufficient Cu NP surfaces. This volcano trend underscores the necessity of balancing the  $^*\text{CO}$  activation and the  $^*\text{H}$  generation for selective acetate formation. These results confirm that the selective acetate formation is a result of the synergistic effect between Cu nanoparticles and Cu single atoms. Additionally, electrochemical impedance spectroscopy (EIS) and double-layer capacitance ( $C_{\text{dl}}$ ) measurements indicate that the coexistence of Cu nanoparticles and single atoms accelerates electron transfer within  $\text{Cu}_{\text{NP}}\text{-Cu}_1$  and provides more active sites (Fig. S14 and S15).

To further investigate the role of  $^*\text{CO}$  coverage in steering product selectivity, we evaluated the CO electroreduction performance of  $\text{Cu}_{\text{NP}}\text{-Cu}_1$  in an alkaline membrane electrode assembly (MEA) electrolyzer under both 0.1 and 1.0 MPa CO. As illustrated in Fig. 3f and S16, at 0.1 MPa CO, the acetate FE reaches 48.5%, with partial current densities of  $184.7 \text{ mA cm}^{-2}$  for  $\text{C}_{2+}$  products and  $94.8 \text{ mA cm}^{-2}$  for acetate. Upon increasing the CO pressure to 1.0 MPa, the acetate FE markedly increases





**Fig. 3** Faradaic efficiency of products over (a)  $\text{Cu}_{\text{NP}}\text{-Cu}_1$ , (b) Cu NPs and (c) the CuSA catalyst in 1.0 M KOH electrolyte. (d) Acetate and (e)  $\text{C}_2+$  current densities as a function of potential over  $\text{Cu}_{\text{NP}}\text{-Cu}_1$ , Cu NPs, and CuSA. (f) Faradaic efficiency of products and cell voltages for the  $\text{Cu}_{\text{NP}}\text{-Cu}_1$  catalyst at 1.0 MPa CO partial pressure in an MEA electrolyzer. (g) Long-term stability of  $\text{Cu}_{\text{NP}}\text{-Cu}_1$  at a potential of  $-1.24$  V vs. RHE in 1.0 M KOH electrolyte. (h) Comparison of this work with the literature benchmarks for CORR electrodes, including acetate/ $\text{C}_2+$  partial current density, acetate/ $\text{C}_2+$  FE, and operation stability.

to 64.0%, and the corresponding partial current density increases to  $127.9 \text{ mA cm}^{-2}$ . This pronounced shift in product distribution provides strong experimental evidence for the proposed synergy between  $^*\text{CO}$  coverage and hydrogen spillover. Elevated CO pressure significantly increases  $^*\text{CO}$  surface coverage on Cu nanoparticles, which not only promotes C-C coupling kinetics but also synergizes with the high  $^*\text{H}$  coverage sustained by hydrogen spillover from adjacent Cu single atoms. These pressure-dependent results thus independently validate the proposed hydrogen spillover mechanism, confirming that the synergy between  $^*\text{CO}$  coverage and  $^*\text{H}$  supply dictates product selectivity.<sup>35–37</sup>

Furthermore, the durability test conducted at  $-1.24$  V vs. RHE reveals that the  $\text{Cu}_{\text{NP}}\text{-Cu}_1$  catalyst remains stable for 132 hours without obvious current decay, maintaining an average acetate faradaic efficiency of 60.6% and an average current density of  $111.1 \text{ mA cm}^{-2}$  (Fig. 3g). Compared with literature benchmarks, this work outperforms state-of-the-art CORR electrodes in terms of acetate partial current density and operation stability (Fig. 3h and Table S3).

### Mechanistic investigation of hydrogen spillover

We characterized the structural changes in the catalyst using quasi *in situ* X-ray photoelectron spectroscopy (XPS) under

oxygen-free conditions to accurately determine the oxidation state of Cu during CO electroreduction. The Cu 2p spectrum (Fig. 4a) reveals peaks corresponding to metallic Cu ( $\text{Cu}^0$ ) at 932.8 eV and single-atom Cu ( $\text{Cu}^{2+}$ ) at 934.6 eV for Cu 2p<sub>3/2</sub>.<sup>38,39</sup> After performing CO electroreduction at  $150 \text{ mA cm}^{-2}$  in a 1.0 M KOH solution, the single-atom Cu in the catalyst is partially reduced to metallic copper. The N 1s spectrum (Fig. 4b) indicates the presence of pyridinic N at 398.7 eV and pyrrolic N at 400.8 eV. Additionally, a Cu-N peak near 399.8 eV suggests coordination between copper sites and nitrogen atoms.<sup>40,41</sup> The decrease in the proportion of pyridinic N after the reaction may be attributed to the breaking of Cu-N bonds during the reaction, leading to the release of single-atom copper. As shown in Fig. 4c, nonlinear least squares fitting (NLLSF) of the Cu LMM Auger spectrum further confirms the coexistence of  $\text{Cu}^{2+}$  and  $\text{Cu}^0$ , with kinetic energies of 917.2 eV and 919.4 eV, respectively.<sup>42–44</sup> The catalyst surface contains a higher abundance of single-atom Cu before the CORR than that after the reaction. Although minor coarsening of the  $\text{Cu}_{\text{NP}}$  is observed in Fig. S17, this structural modification has no detrimental effects on the CORR catalytic performance based on long-term stability results and the unchanged contact angle (Fig. S18). Taken together, these findings demonstrate that the  $\text{Cu}_{\text{NP}}\text{-Cu}_1$  architecture maintains structural integrity through





Fig. 4 Quasi *in situ* XPS spectra of (a) Cu 2p and (b) N 1s of the  $\text{Cu}_{\text{NP}}\text{-Cu}_1$  catalyst in the as-prepared state and after the CO reduction reaction (CORR) at  $150 \text{ mA cm}^{-2}$ . (c) Non-linear least squares fitting (NLLSF) of Cu LMM. (d) The electrochemical CO stripping voltammetry tests of  $\text{Cu}_{\text{NP}}\text{-Cu}_1$ , Cu NPs and CuSA in  $0.2 \text{ M K}_2\text{SO}_4$  electrolyte. (e) *Operando* Raman spectra of the  $\text{Cu}_{\text{NP}}\text{-Cu}_1$  catalyst. (f) The H/D kinetic isotope effect (KIE) on  $\text{Cu}_{\text{NP}}\text{-Cu}_1$  and CuSA catalysts in  $1.0 \text{ M KOH}$  electrolyte.

adaptive restructuring during prolonged electrochemical operation.

Electrochemical CO stripping voltammetry tests were conducted to evaluate the CO adsorption performance of  $\text{Cu}_{\text{NP}}\text{-Cu}_1$ , Cu NPs, and CuSA in a flow cell. The CO desorption peaks for  $\text{Cu}_{\text{NP}}\text{-Cu}_1$  and Cu NPs are located at 0.39 and 0.37 V, respectively, indicating strong CO adsorption on the  $\text{Cu}_{\text{NP}}\text{-Cu}_1$  catalyst (Fig. 4d). No CO desorption peaks were observed for catalysts without adsorbing CO (Fig. S19). A higher CO desorption potential indicates stronger CO adsorption ability.<sup>45,46</sup> Cu SA shows no detectable CO desorption peak, confirming that Cu NPs are the primary sites for  $^*\text{CO}$  activation. This functional separation is the prerequisite for the proposed synergistic mechanism. To probe surface species evolution on  $\text{Cu}_{\text{NP}}\text{-Cu}_1$  during the CORR, *operando* Raman spectroscopy was employed. As depicted in Fig. 4e, spectra acquired from  $-0.5$  to  $-1.5 \text{ V vs. RHE}$  exhibit two characteristic bands, the peak at  $1060 \text{ cm}^{-1}$  corresponding to Cu-H bending vibrations,<sup>47</sup> and the band at  $2080 \text{ cm}^{-1}$  assigned to atop-adsorbed  $^*\text{CO}$  (C≡O stretching).<sup>35,48</sup> The inverse intensity correlation, that is, a decreasing Cu-H signal with increasing  $^*\text{CO}$  adsorption, reveals consumption of adsorbed hydrogen species during CO adsorption at cathodic potentials.<sup>49</sup> In contrast, control experiments with the Cu NP catalyst show no detectable  $^*\text{CO}$  or Cu-H signals until more negative potentials (Fig. S20), demonstrating that  $\text{Cu}_1$  sites critically enhance both  $^*\text{CO}$  adsorption and hydrogen spillover kinetics on adjacent  $\text{Cu}_{\text{NP}}$  surfaces.

To investigate the role of  $\text{Cu}_1$  in water dissociation, the H/D KIE experiments were conducted. When  $\text{D}_2\text{O}$  replaces  $\text{H}_2\text{O}$  in the electrolyte, the production rates of products decrease for  $\text{Cu}_{\text{NP}}\text{-Cu}_1$ , Cu NPs, and CuSA catalysts. The magnitude of this decrease was closely correlated with the ratio of  $\text{Cu}_{\text{NP}}$  to  $\text{Cu}_1$

content. The KIE of H/D is defined as the ratio of production rates in  $\text{H}_2\text{O}$  and  $\text{D}_2\text{O}$  electrolytes. A KIE value close to 1 indicates minimal impact of water dissociation on product formation, whereas a larger KIE suggests a significant influence of hydrogen spillover on the production rate.<sup>28,29</sup> A calibration curve between the concentration of deuterated acetate and deuterated dimethyl sulfoxide (DMSO) was plotted to quantify acetate-d (Fig. S21 and S22). As shown in Fig. 4f, the KIE value for acetate production on Cu SA is 1.4, close to unity, indicating that water dissociation is not rate-limiting. In contrast, Cu NPs exhibit a KIE of 3.4, suggesting that  $^*\text{H}$  supply substantially limits acetate formation on pure Cu NPs.  $\text{Cu}_{\text{NP}}\text{-Cu}_1$  displays a moderate KIE of 2.7, consistent with  $\text{Cu}_1$  sites accelerating water dissociation and supplying  $^*\text{H}$  to Cu NPs. Besides, KIE values for  $\text{C}_2\text{H}_4$  and  $\text{H}_2$  yield present similar trends to that of acetate (Fig. S23). An increase in  $\text{Cu}_1$  content within the catalysts accelerates the water dissociation rate, leading to a decrease in the KIE value. The integration of  $\text{Cu}_1$  into  $\text{Cu}_{\text{NP}}$  amplifies the KIE value for  $\text{C}_2^+$  formation, confirming that  $\text{Cu}_1$ -mediated hydrogen spillover occurs between  $\text{Cu}_1$  and  $\text{Cu}_{\text{NP}}$ .

### DFT calculations

DFT calculations incorporating AIMD simulations were conducted to mechanistically decode the dual-site synergy in the CO electroreduction pathway. The investigation focuses on the  $\text{H}_2\text{O}$  dissociation kinetics for the hydrogen source and C-C coupling. The computational models  $\text{Cu}(100)$  and  $\text{Cu-N}_3$  moiety were constructed to model  $\text{Cu}_{\text{NP}}$  and  $\text{Cu}_1$  sites.<sup>50,51</sup> To identify the primary source of  $^*\text{H}$  supply, we calculated the free energy profiles for  $\text{H}_2\text{O}$  dissociation on both sites using AIMD simulations. The reaction coordinate  $\Delta d$  was defined to track the O-H bond scission, which was expressed as the difference



between the forming and breaking bond lengths:  $\Delta d = d_{\text{H-Cu}} - d_{\text{H-O}}$  on  $\text{Cu}_{\text{NP}}$ , and  $\Delta d = d_{\text{H-N}} - d_{\text{H-O}}$  on  $\text{Cu}_1$  sites<sup>52</sup> (Fig. 5a, b, S24 and S25). The results revealed a clear distinction between the two sites. The energy barrier on  $\text{Cu}(100)$  increased inversely with  $\Delta d$ , reaching 1.38 eV at the final state of  $\text{H}_2\text{O}$  dissociation. The  $\text{Cu-N}_3$  site exhibited a dramatically lower barrier of 0.13 eV, indicating kinetically favorable water dissociation. This direct comparison demonstrates that  $\text{Cu}_1$  sites reduce the  $\text{H}_2\text{O}$  dissociation barrier by 1.25 eV relative to  $\text{Cu}_{\text{NP}}$ , confirming that the single-atom sites are the kinetically favorable centers for generating  $^*\text{H}$  species. This theoretical insight aligns with experimental *operando* Raman spectroscopy and KIE values, corroborating the synergistic mechanism wherein  $\text{Cu}_1$  sites efficiently generate  $^*\text{H}$ , which then spills over to adjacent  $\text{Cu}_{\text{NP}}$  surfaces to facilitate the hydrogenation of key intermediates within the overall CORR pathway.

Given the established significance of the  $^*\text{OCCOH}$  to ketene pathway as selectivity-determining for acetate production, the energetics of  $^*\text{OCCOH}$  formation can be considered a key descriptor for a catalyst's C-C coupling performance and overall  $\text{C}_{2+}$  selectivity. We therefore systematically investigated the impact of  $^*\text{H}$  coverage on this crucial step.<sup>53</sup> DFT calculations

uncovered a coverage-dependent energetic switching behavior.  $^*\text{OCCOH}$  formation becomes increasingly endergonic ( $\Delta G$  up to 1.33 eV) at low  $^*\text{H}$  coverage ( $\theta_{\text{H}} \leq 1/2$  ML). However, at high  $^*\text{H}$  coverage ( $\theta_{\text{H}} = 3/4$  ML), the reaction barrier is dramatically reduced to 1.02 eV (Fig. 5c, S26 and Table S4), enabling the pathway kinetically accessible under operational potentials. These computational insights demonstrate that high  $^*\text{H}$  coverage ( $>1/2$  ML) is favorable for  $^*\text{OCCOH}$  formation, indicating that a high  $^*\text{H}$  concentration is crucial for promoting the overall reaction pathway towards  $\text{C}_{2+}$  products. As shown in Fig. 5d and Table S4, the energy of the acetate intermediate  $^*\text{CCO}$  at  $3/4$  ML coverage is  $-1.64$  eV, which is lower than  $-1.09$  eV at 0 ML coverage. In contrast, the energy of the ethylene intermediate  $^*\text{COHCOH}$  at  $3/4$  ML coverage is  $-0.41$  eV, higher than  $-0.61$  eV at 0 ML coverage. Since a more negative energy indicates a more favorable process, acetate formation becomes more favorable at high  $^*\text{H}$  coverage. This coverage-dependent energetics explains that  $\text{Cu}_1$ -mediated hydrogen spillover directs the selectivity toward acetate over ethylene.

Collectively, our experimental and theoretical results converge on a unified mechanistic picture.  $\text{Cu}_1$  sites in the

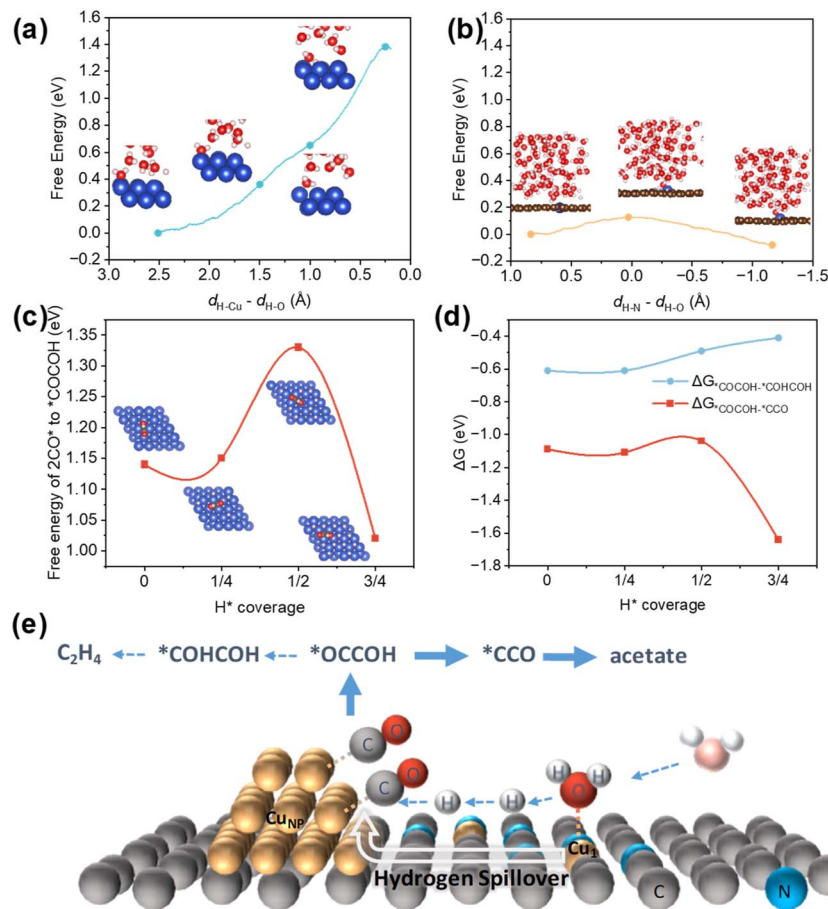


Fig. 5 Free energy profiles and representative structures for  $\text{H}_2\text{O}$  dissociation with different  $\Delta d$  over (a)  $\text{Cu}$  and (b)  $\text{Cu-N}_3$ . (c) Reaction energy of  $^*\text{COCOH}$  formation over  $\text{Cu}$  as a function of  $^*\text{H}$  coverage.  $\text{Cu}$ ,  $\text{O}$ ,  $\text{H}$ , and  $\text{N}$  elements are represented by blue, red, pink and grey spheres. (d) Reaction energy of  $^*\text{COCOH}$  to  $^*\text{CCO}$  and  $^*\text{COCOH}$  to  $^*\text{COHCOH}$  over  $\text{Cu}$  as a function of  $^*\text{H}$  coverage. (e) Schematic diagram of the proposed mechanism for the CORR to acetate on  $\text{Cu}_{\text{NP}}-\text{Cu}_1$ .



Cu<sub>NP</sub>-Cu<sub>1</sub> catalyst function as \*H flux amplifiers to accelerate water dissociation and enable hydrogen spillover onto adjacent Cu<sub>NP</sub>, where \*CO is activated (Fig. 5e). The resulting high \*H coverage on Cu NPs selectively promotes \*OCCO hydrogenation toward acetate, circumventing the kinetic trade-off inherent in conventional Cu catalysts. This mechanism dynamically enhances acetate selectivity by 2.7-fold and 6.5-fold *versus* Cu<sub>NP</sub>-only and Cu<sub>1</sub>-only catalysts, respectively.

## Conclusions

In summary, we have demonstrated that the spatial integration of Cu nanoparticles and Cu single atoms enables a hydrogen spillover mechanism that decouples the kinetic trade-off between CO activation and \*H supply in CO electroreduction. The Cu<sub>1</sub> sites accelerate water dissociation to form \*H, while the proximal Cu NPs enable the \*H-assisted C-C coupling and acetate pathway. This synergy results in impressive acetate selectivity and operation stability, and more importantly, establishes hydrogen spillover as a general strategy for coordinating multistep reactions in complex electrocatalytic systems.

## Author contributions

Conceptualization: D. G. and T. L.; methodology: Q. W., T. L., X. G., P. W., and D. G.; investigation: Q. W. and T. L.; visualization: Q. W. and T. L.; funding acquisition: G. W., D. G., T. L., and Q. W.; supervision: D. G., T. L., G. W., and X. B.; writing—original draft: Q. W. and T. L.; writing—review and editing: D. G., T. L., G. W., and X. B.

## Conflicts of interest

The authors declare no conflict of interest.

## Data availability

The data underlying this article are available in the article and in its online supplementary information (SI). Supplementary information: experimental and theoretical details as well as additional characterization and performance data. See DOI: <https://doi.org/10.1039/d6sc02439d>.

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